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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Walter SCHWARZENBACH et al. Confirmation No.: 3337  
Application No.: 10/766,207 Group Art Unit: 2822  
Filing Date: January 29, 2004 Examiner: Khanh B. Duong  
For: METHOD ~~OF~~ DETACHING A LAYER FROM A WAFER USING A LOCALIZED STARTING AREA Attorney Docket No.: 4717-11600

**AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed September 20, 2005, Applicants respectfully request entry of the following amendments and remarks into the file of this application.

**Amendments to the Specification** appear on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 3 of this paper.

**Remarks** begin on page 6 of this paper.

A **Supplemental Information Disclosure Statement** is enclosed.

A **Certified Copy** of the priority document is also enclosed.

No fee is believed to be due for the claim changes and additions of this submission. Please charge any and all required fees to **Winston & Strawn LLP** Deposit Account No. 50-1814.